



**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT APPLICATION**

In re Application of:

Venkateswaran Atty. Docket: TI-34105.1
Serial No.: 10/789,646 Art Unit: 2813
Filed: 03/01/2004 Examiner: J. Dolan
For: SEMICONDUCTOR DEVICE PACKAGE AND METHOD OF MAKING THE
SAME

Commissioner for Patents
P. O. Box 1450
Alexandria, VA 22313-1450

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I hereby certify that this correspondence is being deposited with the United States Postal Service as First Class Mail in an envelope addressed to: Commissioner for Patents, Alexandria, VA 22313-1450 on the date indicated below.

10-5-2005
Jackie McBride
Jackie McBride

LETTER TO THE OFFICIAL DRAFTSPERSON

Sir:

Please find enclosed eight (8) sheets of replacement formal drawings in the patent application referenced above.

Respectfully submitted,

Texas Instruments Incorporated
P. O. Box 655474, M/S 3999
Dallas, Texas 75265
(972) 917-4371

Wade James Brady III
Attorney for Applicant
Reg. No. 32,080